

Low EMI Stereo Class D Audio Amplifier

General Description

The VA2246 is a cost-effective filter-less Class D stereo audio power amplifier that operates in wide range of various power supplies. VA2246 is designed with fixed 26dB gain setting. VA2246 can output 8.8W per channel into 8Ω load with lower supply current and fewer external components for driving bridged-tied stereo speaker directly with excellent EMI performance. With the function of power limit, the speakers could be operated safely.

VA2246 operates with high efficiency energy conversion up to 85% (Stereo 8Ω Load) so that the external heat sink can be eliminated while playing music.

VA2246 also integrates Anti-Pop, Output Short & Over-Heat Protection Circuitry to ensure device reliability. This device also provides the DC detect and protection scheme to prevent the damage of Applications speaker voice coils.

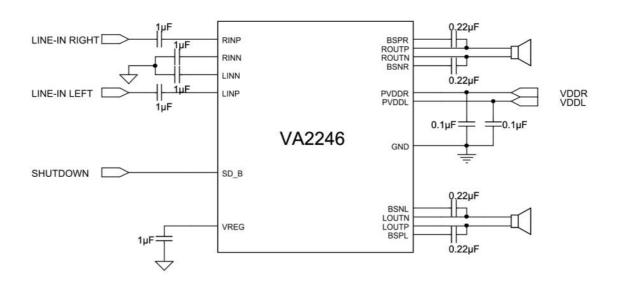
The VA2246 is available in small SOP-16EP green package with exposed pad.

Features

- Operation Voltage from 6V to 18V
- Excellent EMI Performance for Filter-Free Operation
- Maximum 85% Efficiency BTL Mode @8Ω
- $8.8W@8\Omega$ Load at 12V with THD+N=10%
- 12.3W@4 Ω Load at 12V with THD+N=10%
- 26dB Fixed Gain Setting
- Support Parallel BTL (Mono) Operation
- Speaker DC Detection and Protection
- Thermal Protection with Auto-Recovery
- Speaker Protection Circuitry
- Short Circuit and Thermal Protection
- RoHS 2.0 compliant SOP-16EP Green Package with Exposed Pad

- LCD TV
- Multimedia Speakers
 - Sound Bar

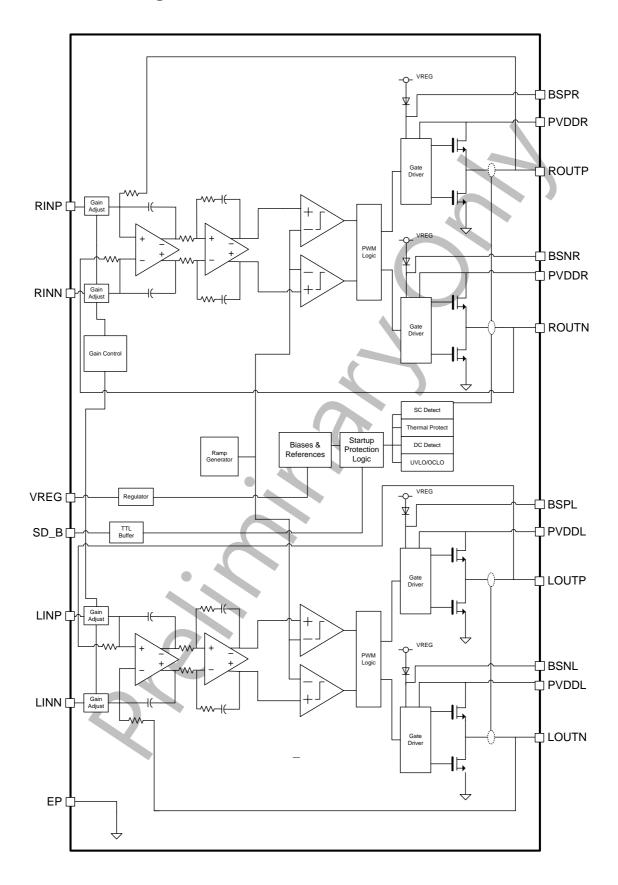
Typical Application



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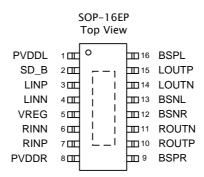


Functional Block Diagram





Pin Assignments And Descriptions



D: 11	D'	1.40.45	Function Description		
Pin No.	Pin	I/O/P	Function Description		
1	PVDDL	Р	Left Channel power supply.		
2 SD_B		CD R	Shutdown control terminal. Low active. TTL Logic levels with compli-		
2	30_6	'	ance to PVDDL/PVDDR.		
3	LINP		Left channel positive audio signal input. Tie this pin low if need to		
	LIIVI	'	bridge rear side of outputs.		
4	4 LININI	LINN		Left channel negative audio signal input. Tie this pin low if need to	
7	LIMIN	'	bridge rear side of outputs.		
5	VREG	0	Regulated voltage. Nominal voltage is 5.75V.		
6	RINN	I	Right channel negative audio signal input.		
7	RINP	I	Right channel positive audio signal input.		
8	PVDDR	Р	ght channel power supply		
9	BSPR	_	otstrap I/O for right channel positive high-side switch.		
10	ROUTP	0	ght channel positive output.		
11	ROUTN	0	Right channel negative output.		
12	BSNR	_	Bootstrap I/O for right channel negative high-side switch.		
13	BSNL	_	Bootstrap I/O for left channel negative high-side switch.		
14	LOUTN	0	Left channel negative output.		
15	LOUTP	0	Left channel positive output.		
16	BSPL	_	Bootstrap I/O for left channel positive high-side switch.		
EP	GND	Р	ystem ground.		



Absolutely Maximum Ratings

Over operating free-air temperature range, unless otherwise specified (* 1)

Symbol	Parameter	Limit	Unit
V _{DD} (PVDDR, PVDDL)	Supply voltage	-0.3 to 22	V
V _i (SD_B)	Input voltage	-0.3 to V _{DD} +0.3	V
V _I (LINN, RINN, LINP, RINP)	Input voltage	-0.3 to 6.5	V
T _A	Operating free-air temperature range	-40 ~ +85	°C
T _J	Operating junction temperature range	-40 to +150	°C
T_{STG}	Storage temperature range	-65 to 150	°C
R _(LOAD)	Minimum load resistance	8 (V _{DD} >12V) 4 (V _{DD} ≤12V)	Ω
θ_{JC}	Thermal Resistance (Junction to Case)	10	°C/W
θ_{JA}	Thermal Resistance (Junction to Air)	45	°C/W
Electrostatic discharge	Human body model	±2	kV
Electrostatic discharge	Machine model	±200	V

^{(*1):} Stress beyond those listed at "absolute maximum rating" table may cause permanent damage to the device. These are stress rating ONLY. For

Recommended Operating Conditions

Over operating free-air temperature range, unless otherwise specified. \\

Symbol	Parameter	Test Condition	Specifi	Unit	
Зуппьог	raiailletei	rest Condition	Min	Max	Oilit
V_{DD}	Supply voltage	PVDDL, PVDDR	6	18	V
V _{IH}	High level input voltage (SD_B)	V _{DD} =12V	2		٧
V _{IL}	Low level input voltage (SD_B)	$V_{DD}=12V$		0.4	٧
T _A	Operating free-air temperature		-40	85	°C



Electrical Characteristics

 $T_A = 25^{\circ}\text{C}$, $V_{DD} = 12\text{V}$, $R_L = 8\Omega$, unless otherwise noted.

Symbol	Parameter	Test Condition		Specification			Unit
Syllibol	raidilletei			Min	Тур.	Max	Oilit
V _{os}	Output offset voltage (measured differentially)	$V_1 = 0V$			1.5	15	mV
I _Q	Quiescent current	SD_B=2V,	No load		30	50	mA
I _{SD}	Shutdown current	SD_B=0.8V, No load			300	500	μΑ
t _{on}	Shutdown turn-on time	SD_B=2V			20		ms
t _{OFF}	Shutdown turn-off time	SD_B=0.8V			2		μs
f_{OSC}	Internal oscillation frequency				300		kHz
Α	Amplifier gain				26		dB
D	Drain-Source ON resistance ¹	$V_{DD}=12V$,	High Side		240		mΩ
$R_{DS(ON)}$		$I_{OUT} = 500 mA$	Low Side		240		111122
V_{REG}	Regulator output	$I_{VREG} = 100 \mu A, V_{DD} = 6 \sim 18 V$		5.55	5.75	5.95	V
t _{DC-DET}	DC detect time				450		ms

⁽¹⁾ Design center value.



Operating Characteristics

 V_{DD} =12V, T_A = 25°C unless otherwise noted.

Symbol	Darameter	Test Condition		Specification			Unit	
Symbol	Parameter			Min	Тур.	Max	Ollic	
		PVDD=12V, f=1kHz,	THD+N = $1\%^{1}$		10		W	
	Output nouser	$R_L=4\Omega$	THD+N=10% ¹		12.3		• • •	
Po	Output power	PVDD=12V, f=1kHz,	THD+N=1%		7		\ A/	
		$R_L = 8\Omega$	THD+N=10%		8.8		W	
THD+N	Total harmonic dis- tortion plus noise	$V_{DD}=12V, P_{O}=5W, R_{L}=8\Omega, f=1kHz$		1//	0.2		%	
V _{os}	Offset voltage				20		mV	
K _{SVR}	Supply ripple rejec- tion ration	Input AC-Grounded, $C_i=1 \mu F$, $f=1 kHz$			68		dB	
SNR	Signal-to-Noise ratio	A–weighted, THD+N=1%, R_L =8 Ω			93		dB	
V _n	Output voltage noise	C _i =1µF, f=20Hz to 20k Input AC-Grounded		160		μV_{RMS}		
CMRR	Common mode re- jection ratio	V_{DD} =12V, V_{IC} =1 V_{PP}	f=120Hz		66		dB	
Zı	Input impedance				60		kΩ	
Crosstalk	Channel separation	V ₀ =1W, f=1kHz			94		dB	

(1)Heat-sink is required.



Functional Descriptions

Gain Setting

The gain of the VA2246 is fixed on 26dB. The input resistance is depended on the gain setting and the nominal input resistance is $30k\Omega$. Since the gain setting is determined by the ratio of the internal feedback resistive network, the variation of the gain is small. But the absolute value of the input resistance may shift by $\pm 20\%$. In actual design cases, 80% of nominal value should be assumed as the input resistance of VA2246 in the input network of whole amplifier.

Amplifier Input Impedance

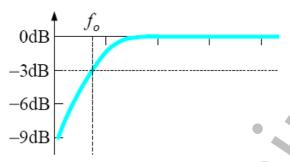


Figure 1. Cut-off point of high-pass filter

In most cases, no extra resistor needs to be added on the input of VA2246. The actual input resistor is already determined with the gain. If a single capacitor is used in the input high-pass filter, the cut -off frequency fo may vary with the change of gain setting. The -3dB point of the cut-off frequency can be calculated by the following equation,

$$fo = \frac{1}{2\pi \times R_{I} \times C_{I}}$$

,where the R_I values is fixed at 30kΩ.

Shutdown Operation

The VA2246 employs a state of shutdown mode to The minimum differential input DC voltages re-

reduce supply current to the absolute minimum level during periods of nonuse for power conservation. This terminal should be held high during normal operation when the amplifier is in normal operating. Pulling low causes the output drivers shutdown and the amplifier to enter a low-current state. Do not leave it unconnected, because there is no weakly pulling resistor inside the amplifier.

Remember that to place the amplifier in the shutdown state prior to removing the power supply voltage so that power-off pop noise can be eliminated.

VREG Supply

The V_{REG} Supply is used to bias the gates of the output full-bridge upper half MOSFETs. It could be used to supply the PLIMIT pin and related voltage divider circuit. Add at least 1µF capacitor to ground at this pin.

Speaker Protection

Due to the nature of Class D amplifiers, the speakers may have DC current if the audio inputs get DC voltage in any case. An output DC fault will shut down the audio amplifier and change the state of output into high impedance and the amplifier will be auto recovery again.

To resolve the case of DC input, it is good to treat it as very low frequency sine wave much lower than audio band such as 2Hz. Based on this criteria, a DC detect fault shall be issued when the output differential duty-cycle of either channel exceeds 14% for more than 500ms at the same polarity. This feature protects the speakers away from large currents.



Functional Descriptions (cont.)

quired to trigger the DC detection fault is 56mV.

To resume the normal operation, it is necessary to power off the amplifier and then power on, cycling SD_B can not resume normal operation.

Short Circuit Protection

VA2246 has protection from over-current conditions caused by a short circuit on the output stage. The amplifier outputs are switched to a high impedance state when the short circuit protection latch is engaged. The VA2246 will attempt to power on again and the fault will be auto recovery if the short issue has been resolved.

Thermal Protection

Thermal protection on the VA2246 prevents damage to the device when the internal die temperature exceeds 150° C. There is a $\pm 20^{\circ}$ C tolerance on this trip point from device to device. Once the die temperature exceeds the thermal set point, the device enters into the shutdown state and the outputs are disabled. This is not a latched fault. The thermal fault is cleared once the temperature of the die is reduced by 30° C. VA2246 will be back to normal operation at this point with no external system interaction.



Application Information

Output Filter

Many applications require a ferrite bead filter at least. The ferrite filter reduces EMI above 30MHz. When selecting a ferrite bead, choose one with high impedance at high frequencies, but low impedance at low frequencies, be aware of its maximum current limitation. The VA2246 has built-in adapted modulation scheme for better EMI performance.

Use an LC output filter if there are low frequency (<1 MHz) EMI sensitive circuits and there are long wires from the amplifier to the speaker.

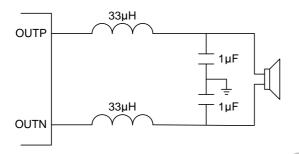


Figure 2. Typical LC Output Filter, Speaker Impedance= 8Ω

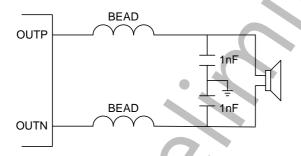


Figure 3. Typical Ferrite Chip Bead Output Filter

Inductors used in LC filters must be selected carefully. A significant change in inductance at the peak output current of the VA2246 will cause increased distortion. The change of inductance at currents up to the peak output current must be less than 0.1µH per amp to avoid this. Also note that smaller inductors than 33µH may cause an increase in distortion above what is shown in preceding graphs of

THD versus frequency and output power. In all cases, avoid using inductors which value are less than $22\mu H$.

Like the selection of the inductor in LC filters, the capacitor must be selected carefully, too. A significant change in capacitance at the peak output voltage of the VA2246 will cause increased distortion. LC filter capacitors should be double of DC voltage ratings of the peak application voltage (the power supply voltage) at least. In general, it is strongly recommended using capacitors with good temperature performance like X5R series.

Output Snubbers

In Figure 4, the 330pF capacitors in series with 10Ω resistors connected with the outputs of the VA2246 are snubber circuits. They smooth switching transitions and reduce overshoot and ringing. With these networks, THD+N can be improved at lower power levels and EMC can be reduced 2~4 dB at middle frequencies. They increase quiescent current by $3mA\sim11mA$ depending on supply voltage.

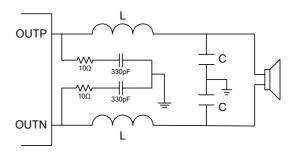


Figure 4. Output Snubber Circuits

Low ESR Capacitors

Low ESR capacitors are high recommended for this application. In general, a practical capacitor can be modeled simply as a resistor in series with an ideal capacitor. The voltage drop across this unwanted



Application Information (cont.)

resistor can eliminate the effects of the ideal capacitor. Place low ESR capacitors on supply circuitry can improve THD+N performance.

Boot-Strap Capacitors

The full H-bridge output stages use only MOS transistors. Therefore, they require bootstrap capacitors for the high side of each output to turn on correctly. A 0.22µF ceramic capacitor, rated for at least 25V, must be connected from each output to its corresponding boot-strap input. Specifically, one 0.22µF capacitor must be connected from xOUTP to BSPx, and one 0.22µF capacitor must be connected from xOUTN to BSNx.

The bootstrap capacitors connected between the BSPx or BSNx pins and corresponding output function as a floating power supply for the high side N-channel power MOSFET gate drive circuitry. During each high side switching cycle, the bootstrap capacitors hold the gate-to-source voltage high enough to keep the high-side MOSFETs turned on.

Decoupling Capacitors

VA2246 requires appropriate power decoupling to minimize the output total harmonic distortion (THD) and improves EMC performance. Power supply decoupling also prevents intrinsic oscillations for long lead lengths between the amplifier and the speaker. The optimum decoupling can be achieved by using two different types of capacitors which target different types of noise on the power supply lines. For higher frequency spikes, or digital hash on the rail, a good low ESR ceramic capacitor, for example 0.1 µF to 10 µF, placed as close as possible to PVDDR and PVDDL pins works best. For filtering lower frequency noise, a larger low ESR aluminum electrolytic capacitor of 470 µF or greater placed near the audio power amplifier is suggested. The

470μF capacitor also serves as local storage capacitor for supplying current during heavy power output on the amplifier outputs. The PVDDR and PVDDL terminals provide the power to the output transistors, so a 470μF or larger capacitor should be placed by PVDDR and PVDDL terminals as near as possible. A 10μF ceramic capacitor on each PVDDR/PVDDL terminal is also recommended.



Application Circuit

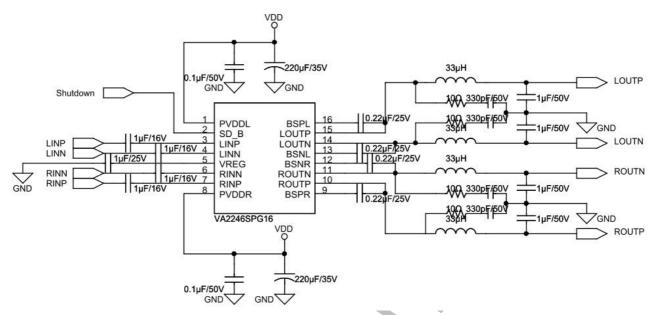


Figure 5. VA2246 Stereo Reference Application

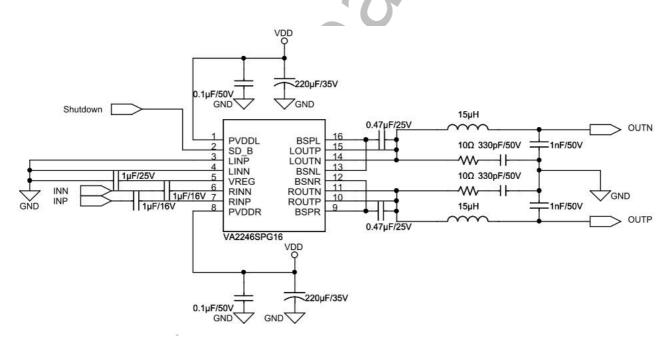


Figure 6. VA2246 Mono Reference Application



Application Circuit (cont.)

The dimension of aluminum heat sink used on the EVB is 14mmx25mmx50mm with three fins (shown below). For additional information of the heat sink, please visit https://www.genye.com.tw

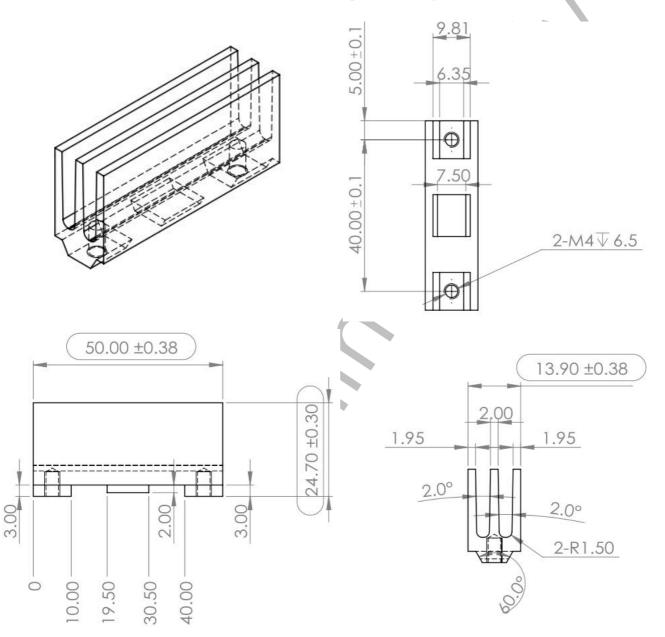
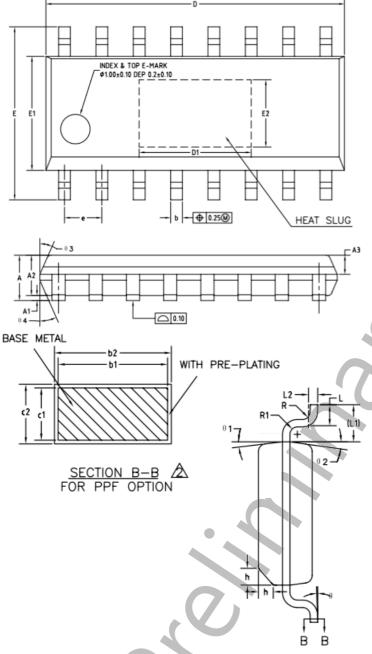


Figure 7. Recommended heatsink outline and dimensions



Package Information

SOP-16P



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

	SY	MBOL	MIN	NOM	MAX		
2	Α		1.35	1.52	1.70		
	Α1		0.02	0.07	0.12		
	A2		1.35	1.45	1.55		
	A3		0.55	0.65	0.75		
◬	Ь		0.38	ı	0.47		
Δį	b1		0.37	0.40	0.43		
Δ	b2		0.371	1	0.44		
2	С		0.20		0.25		
	c1		0.19	0.20	0.21		
2	c2		0.191	ı	0.22		
	D		9.86	9.96	10.06		
<u>A</u>	D1	OPTION1	3.30	3.81	4.00		
	01	OPTION2	3.70	4.06	4.20		
	E		5.80	6.00	6.20		
	E1		3.80	3.90	4.00		
<u>A</u>	E2	OPTION1	1.78	2.29	2.50		
	LZ	OPTION2	1.70	2.08	2.20		
<u>A</u>	е		1.17	1.27	1.37		
	L		0.45	0.60	0.80		
	L1		1.04REF				
	L2		0.25BSC				
	R		0.07	_	_		
	R1		0.07	_	_		
	h		0.30	0.40	0.50		
	θ		0,	_	8*		
	θ 1		6*	8*	10°		
	θ 2		6*	8*	10°		
	θ 3		5*	7°	9,		
	θ 4		5*	7*	9•		

Notes:

Package Outline Unit Description:
 BSC: Basic. Represents theoretical exact dimension or dimension target.

MIN: Minimum dimension specified.

MAX: Maximum dimension specified.

REF: Reference. Represents dimension for reference use only. This value is not a device specification.

NOM: Nominal. Provided as a general value. This value is not a device specification.

- 2. Dimensions in Millimeters
- JEDEC Outline: MS-012 BC
 Dimensions "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusions and gate burrs shall not exceed 0.51mm
- 5. Dimensions "E" does not include inter-lead flash, or protrusions. Inter-lead flash and protrusions shall not exceed 0.25mm per side.



Contact Information

Viva Electronics Incorporated

10F-1, No. 32, Gaotie 2nd Rd., Zhubei City, Hsinchu County, Taiwan, R.O.C.

Tel: 886-3-6579508 Fax: 886-3-6579509

WWW: http://www.viva-elec.com.tw

Sales: sales@viva-elec.com.tw

FAE Support: fae@viva-elec.com.tw

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